

# DATA SHEET

## **BYC8B-600**

Rectifier diode

ultrafast, low switching loss

Product specification

March 2001



**WeEn**

WeEn Semiconductors

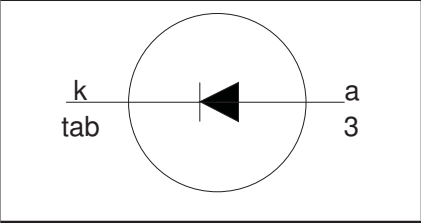
Rectifier diode  
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BYC8B-600

FEATURES

- Extremely fast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET

SYMBOL



QUICK REFERENCE DATA

$V_R = 600\text{ V}$
$V_F \leq 1.85\text{ V}$
$I_{F(AV)} = 8\text{ A}$
$t_{rr} = 19\text{ ns (typ)}$

APPLICATIONS

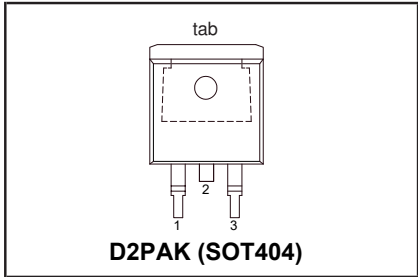
- Active power factor correction
- Half-bridge lighting ballasts
- Half-bridge/ full-bridge switched mode power supplies.

The BYC8B-600 is supplied in the SOT404 surface mounting package.

PINNING

PIN	DESCRIPTION
1	no connection
2	cathode <sup>1</sup>
3	anode
tab	cathode

SOT404



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{RRM}$	Peak repetitive reverse voltage		-	600	V
$V_{RWM}$	Crest working reverse voltage		-	600	V
$V_R$	Continuous reverse voltage		-	500	V
$I_{F(AV)}$	Average forward current	$T_{mb} \leq 110\text{ °C}$ $\delta = 0.5$ ; with reappplied $V_{RRM(max)}$ ;	-	8	A
$I_{FRM}$	Repetitive peak forward current	$T_{mb} \leq 82\text{ °C}$ $\delta = 0.5$ ; with reappplied $V_{RRM(max)}$ ;	-	16	A
$I_{FSM}$	Non-repetitive peak forward current.	$T_{mb} \leq 82\text{ °C}$ $t = 10\text{ ms}$ $t = 8.3\text{ ms}$ sinusoidal; $T_j = 150\text{ °C}$ prior to surge with reappplied $V_{RWM(max)}$	-	55 60	A A
$T_{stg}$	Storage temperature		-40	150	°C
$T_j$	Operating junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	-	2.2	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	minimum footprint, FR4 board	-	50	-	K/W

<sup>1</sup> it is not possible to make connection to pin 2 of the SOT404 package

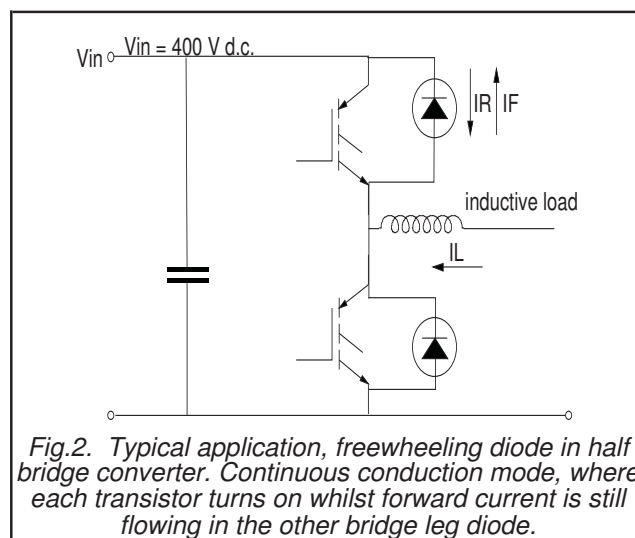
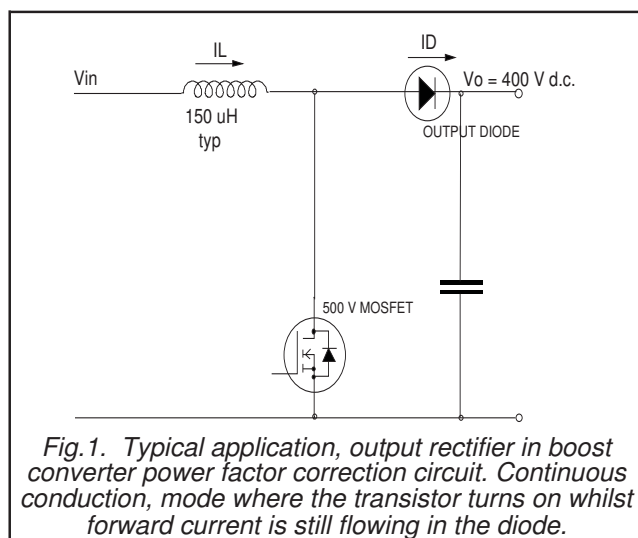
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## ELECTRICAL CHARACTERISTICS

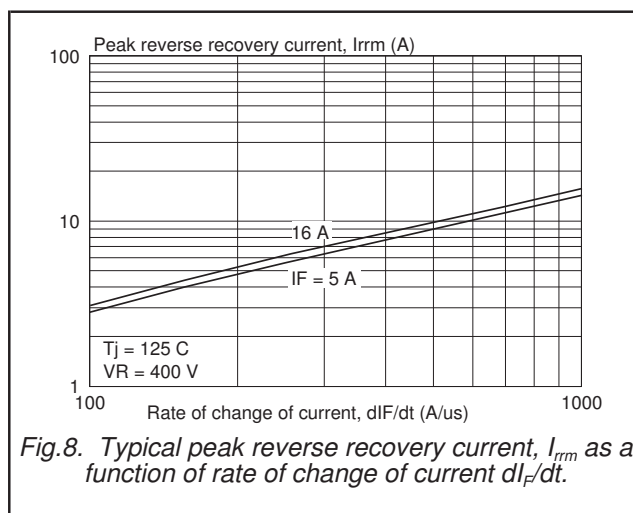
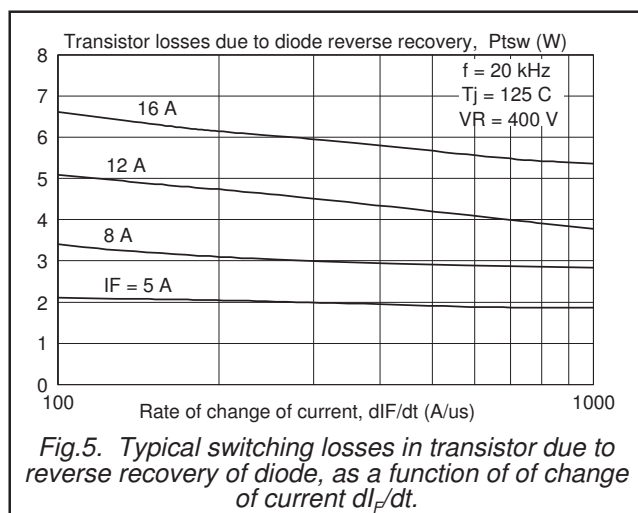
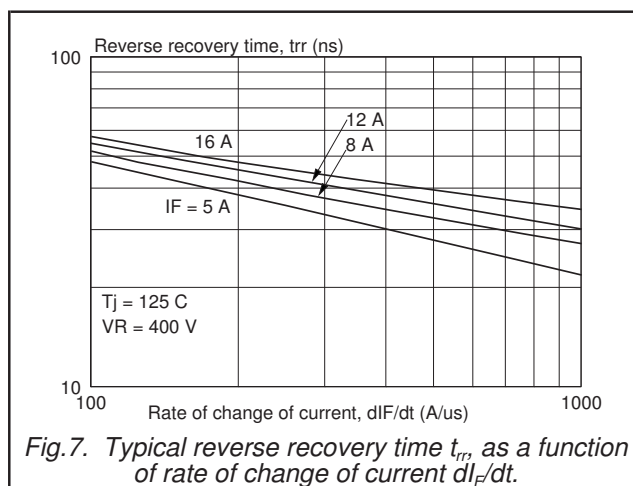
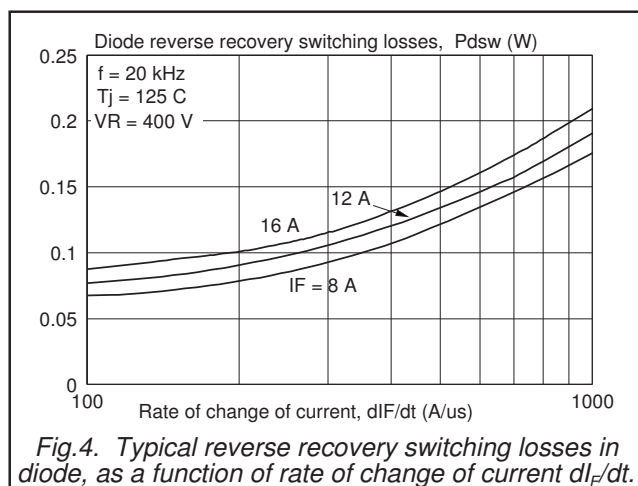
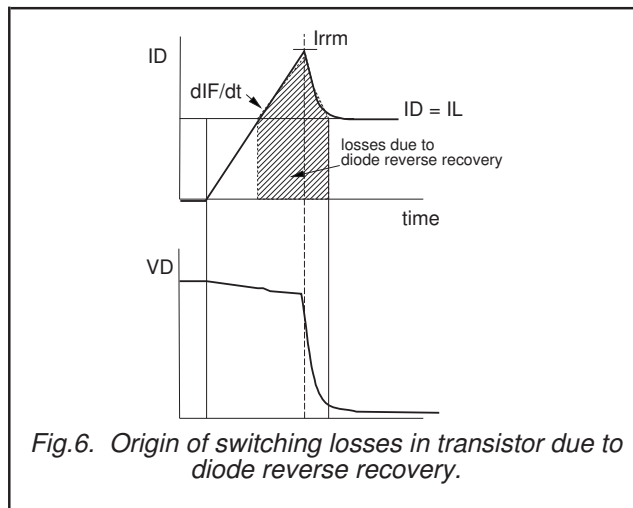
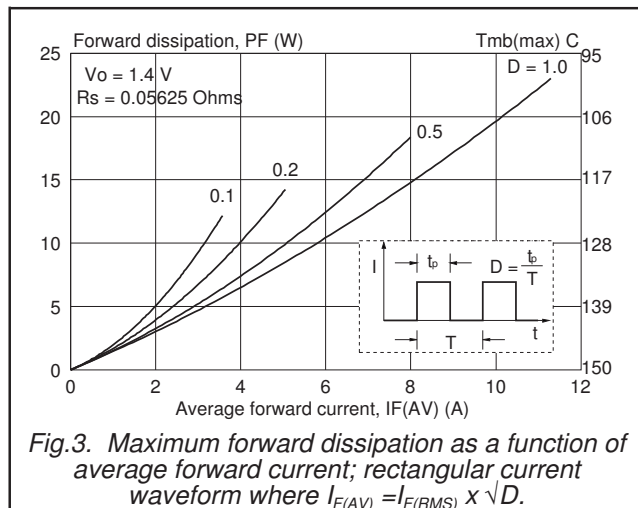
 $T_j = 25\text{ }^{\circ}\text{C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_F$	Forward voltage	$I_F = 8\text{ A}$ ; $T_j = 150\text{ }^{\circ}\text{C}$	-	1.4	1.85	V
		$I_F = 16\text{ A}$ ; $T_j = 150\text{ }^{\circ}\text{C}$	-	1.7	2.3	V
$I_R$	Reverse current	$I_F = 8\text{ A}$ ; $V_R = 600\text{ V}$	-	2.0	2.9	V
		$V_R = 500\text{ V}$ ; $T_j = 100\text{ }^{\circ}\text{C}$	-	9	150	$\mu\text{A}$
			-	1.1	3.0	mA
$t_{rr}$	Reverse recovery time	$I_F = 1\text{ A}$ ; $V_R = 30\text{ V}$ ; $di_F/dt = 50\text{ A}/\mu\text{s}$	-	30	52	ns
$t_{rr}$	Reverse recovery time	$I_F = 8\text{ A}$ ; $V_R = 400\text{ V}$ ; $di_F/dt = 500\text{ A}/\mu\text{s}$	-	19	-	ns
$t_{rr}$	Reverse recovery time	$I_F = 8\text{ A}$ ; $V_R = 400\text{ V}$ ; $di_F/dt = 500\text{ A}/\mu\text{s}$ ; $T_j = 100\text{ }^{\circ}\text{C}$	-	32	40	ns
$I_{rrm}$	Peak reverse recovery current	$I_F = 8\text{ A}$ ; $V_R = 400\text{ V}$ ; $di_F/dt = 50\text{ A}/\mu\text{s}$ ; $T_j = 125\text{ }^{\circ}\text{C}$	-	1.5	5.5	A
$I_{rrm}$	Peak reverse recovery current	$I_F = 8\text{ A}$ ; $V_R = 400\text{ V}$ ; $di_F/dt = 500\text{ A}/\mu\text{s}$ ; $T_j = 125\text{ }^{\circ}\text{C}$	-	9.5	12	A
$V_{fr}$	Forward recovery voltage	$I_F = 10\text{ A}$ ; $di_F/dt = 100\text{ A}/\mu\text{s}$	-	8	10	V



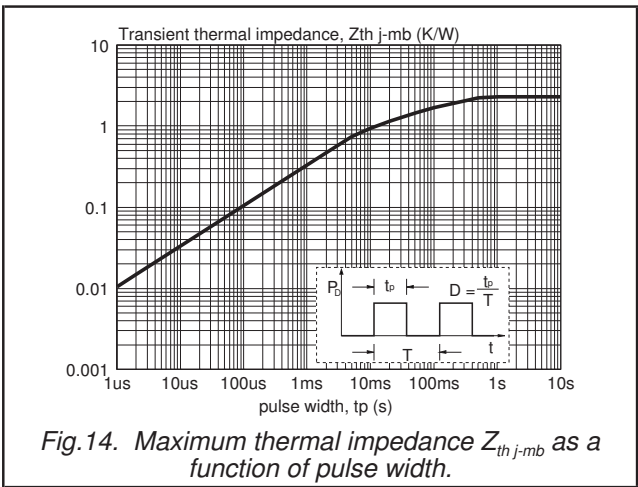
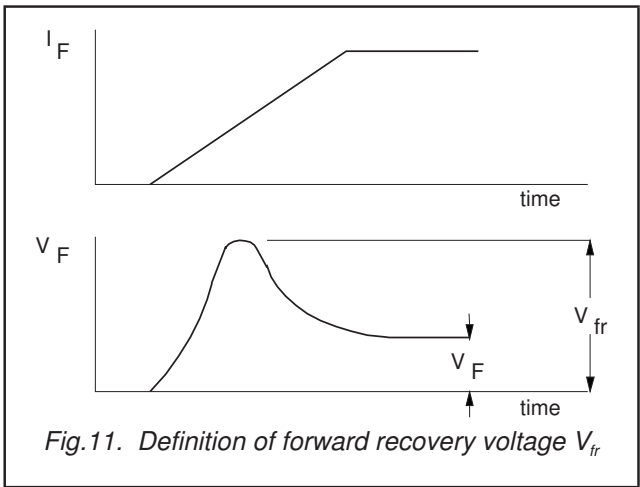
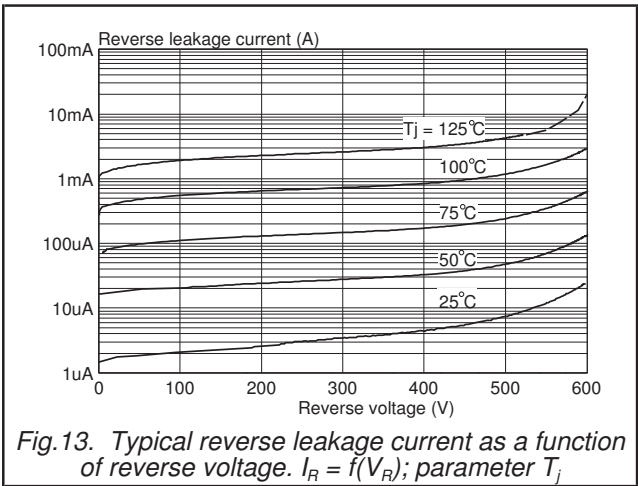
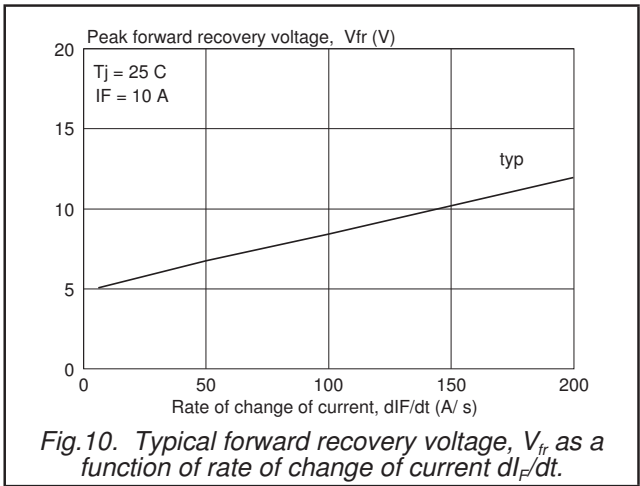
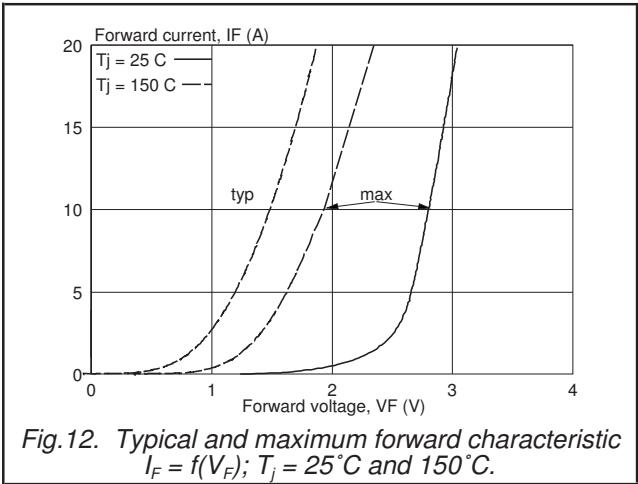
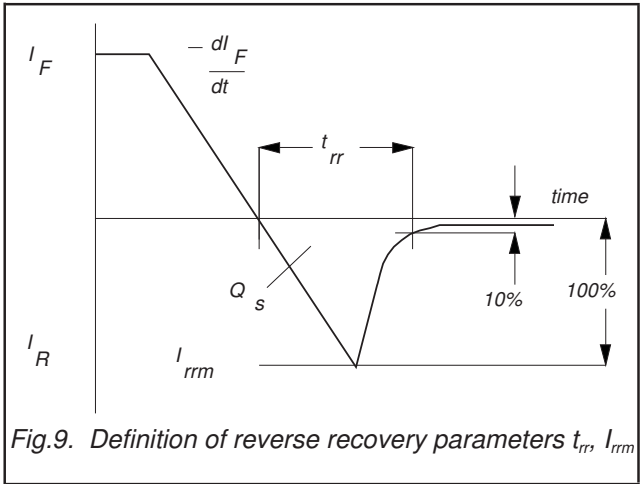
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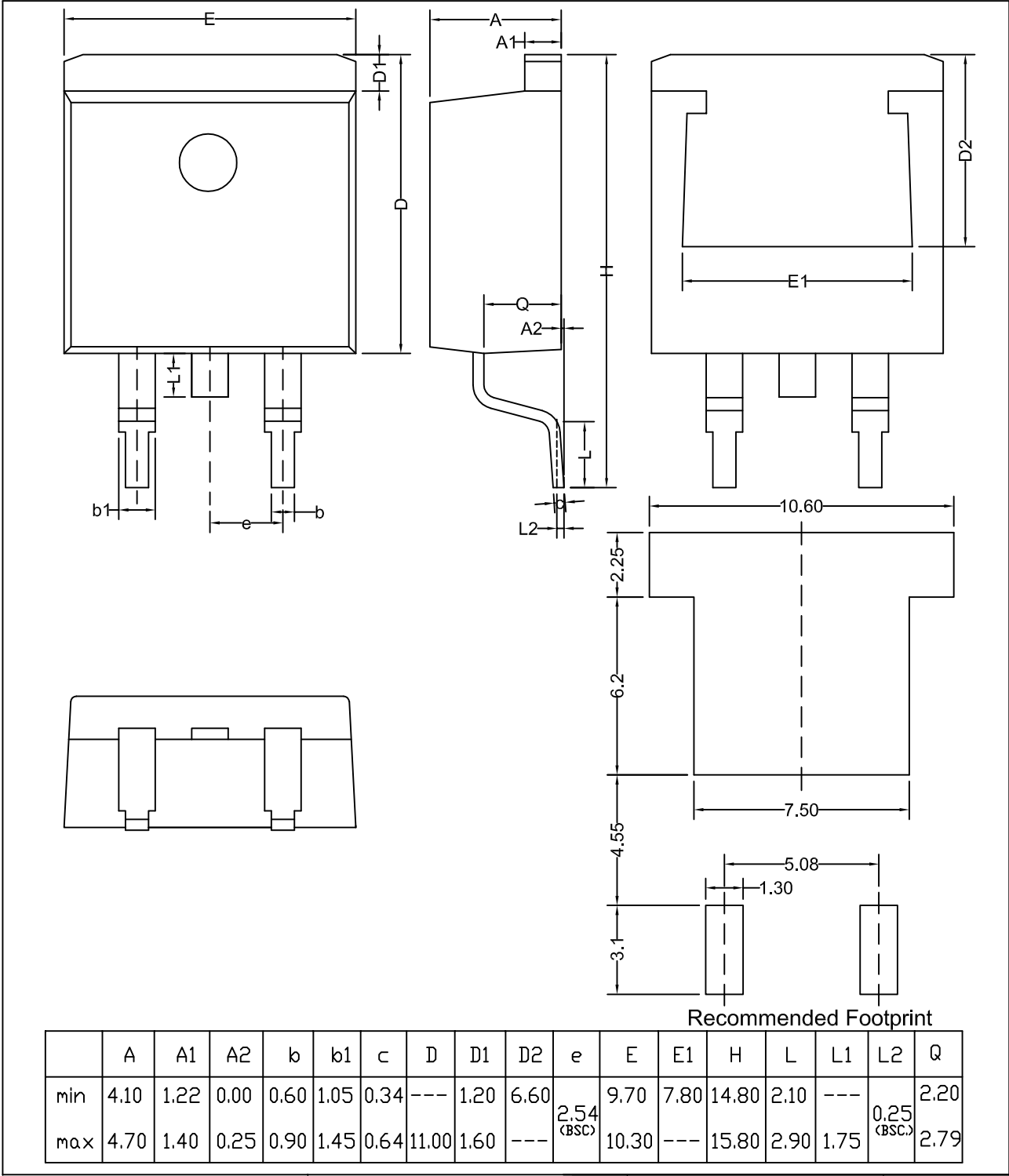


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MECHANICAL DATA

Plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped) TO263



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### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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